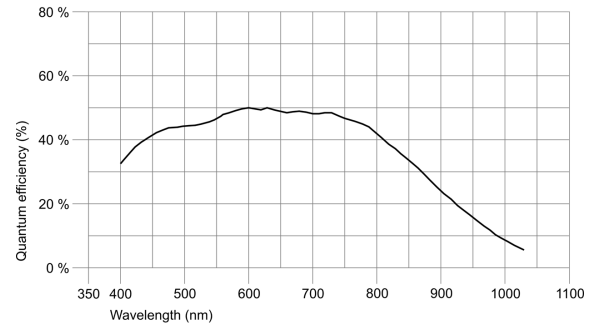




Specification

Sensor

Sensor type	CMOS Mono
Shutter	Global Shutter
Sensor characteristic	Linear with knee points
Readout mode	Progressive scan
Pixel Class	WVGA
Resolution	0.36 Mpix
Resolution (h x v)	752 x 480 Pixel
Aspect ratio	14:9
ADC	10 bit
Color depth (camera)	12 bit
Optical sensor class	1/3"
Optical Size	4.512 mm x 2.880 mm
Optical sensor diagonal	5.35 mm (1/2.99")
Pixel size	6 µm
Manufacturer	ON Semiconductor
Sensor Model	MT9V032C12STM
Gain (master/RGB)	4x/-
AOI horizontal	increased frame rate
AOI vertical	increased frame rate
AOI image width / step width	16 / 4
AOI image height / step width	4 / 2
AOI position grid (horizontal/vertical)	4 / 2
Binning horizontal	increased frame rate
Binning vertical	increased frame rate
Binning method	Mono
Binning factor	2 / 3
Subsampling horizontal	increased frame rate
Subsampling vertical	increased frame rate
Subsampling method	-
Subsampling factor	2, 4



Model

Pixel clock range	5 MHz - 46 MHz
Frame rate freerun mode	100
Frame rate trigger (maximum)	96
Exposure time (minimum - maximum)	0.070 ms - 5580 ms
Power consumption	2.3 W - 3.1 W
Image memory	60 MB

Ambient conditions

The temperature values given below refer to the outer device temperature of the camera housing.

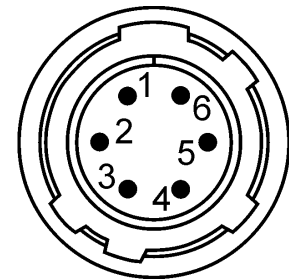
Device temperature during operation	0 °C - 55 °C / 32 °F - 131 °F
Device temperature during storage	-20 °C - 60 °C / -4 °F - 140 °F
Humidity (relative, non-condensing)	20 % - 80 %

Connectors

Interface connector	GigE RJ45, screwable
I/O connector	6-pin Hirose connector (HR10A-7R-6PB)
Power supply	12 V - 24 V

Pin assignment I/O connector

1	Ground (GND)
2	Power supply (VCC)
3	Trigger input with optocoupler (-)
4	Trigger input with optocoupler (+)
5	Flash output with optocoupler (+)
6	Flash output with optocoupler (-)



Camera rear view

Design

Lens Mount	C-Mount
IP code	IP30
Dimensions H/W/L	34.0 mm x 44.0 mm x 49.8 mm
Mass	102 g

